

Normal Tg & High CTI Material & Conventional  
NY1600/NY1600P

特点 FEATURES:

- 优秀的耐漏电起痕性 CTI > 600V (IEC60112方法) Excellent Tracking Resistance CTI>600V (IEC60112 Method)
- Tg135℃ FR-4板材 Tg135℃ FR-4
- 优秀的剥离强度 Excellent Peel Strength
- UV Blocking和AOI兼容 UV Blocking/AOI Compatible
- 低的吸水率 Low Water Absorption
- 优秀的尺寸安定性 Excellent Dimension Stability

应用领域 APPLICATIONS:

- 消费电子类 Consumer Electronics
- 仪器仪表 Instrumentations
- 家电产品如洗衣机、等离子电视等 Home appliances such as washing machine plasma TV, etc

NY1600基板典型性能 Typical Properties for NY1600 Laminate

| 属性<br>Property            | 项目<br>Item               |                      | 测试方法<br>IPC-TM-650 | 测试条件<br>Test Condition | 单位<br>Unit        | 典型值<br>Typical Value |                     |               |
|---------------------------|--------------------------|----------------------|--------------------|------------------------|-------------------|----------------------|---------------------|---------------|
| 热性能<br>Thermal            | 玻璃态转换温度 Tg               |                      | 2.4.25             | DSC                    | ℃                 | 135                  |                     |               |
|                           |                          |                      | 2.4.24             | TMA                    | ℃                 | \                    |                     |               |
|                           |                          |                      | 2.4.24.4           | DMA                    | ℃                 | \                    |                     |               |
|                           | X/Y轴热膨胀系数CTE,X/Y-axis    |                      | 2.4.24.5           | < Tg,TMA               | PPM/℃             | 13\14                |                     |               |
|                           | Z轴热膨胀系数<br>Z-axis        |                      | 2.4.24             | < Tg,TMA               | PPM/℃             | 65                   |                     |               |
|                           |                          |                      |                    | > Tg,TMA               | PPM/℃             | 310                  |                     |               |
|                           |                          |                      | 2.4.24             | 50~260℃                | %                 | 4.5                  |                     |               |
|                           | 热裂解温度 Td                 |                      | 2.4.24.6           | TGA(5%W.L)             | ℃                 | 315                  |                     |               |
|                           | 耐热性 T288                 |                      | 2.4.24.1           | Clad                   | Min               | 2                    |                     |               |
| Etched                    |                          |                      |                    | Min                    | 2                 |                      |                     |               |
| 电性能<br>Electrical         | 介电常数 DK<br>(R/C:55%/70%) |                      | 1MHz               | 2.5.5.9                | C-24/23/50        | -                    | 4.25\3.90           |               |
|                           |                          |                      | 1GHz               |                        |                   |                      | SPDR method         | 3.90\3.50     |
|                           |                          |                      | 10GHz              |                        |                   |                      |                     | \             |
|                           | 介质损耗 Df<br>(R/C:55%/70%) |                      | 2.5.5.9            | C-24/23/50             | -                 | 1MHz                 |                     | \             |
|                           |                          |                      |                    |                        |                   | 1GHz                 | 0.0175\0.0194       |               |
|                           |                          |                      |                    |                        |                   | 10GHz                | SPDR method         | 0.0191\0.0209 |
|                           | 体积电阻 Volume Resistivity  |                      |                    | 2.5.17.1               | C-96/35/90        | MΩ-cm                | 4.9×10 <sup>8</sup> |               |
|                           | 表面电阻 Surface Resistivity |                      |                    |                        |                   | MΩ                   | 5.8×10 <sup>7</sup> |               |
|                           | 物理性能<br>Physical         | 吸水率 Water Absorption |                    | 2.6.2.1                | E-1/105+D-24/23   | %                    | 0.4                 |               |
| 剥离强度 Peel Strength (HTE)  |                          | 1oz                  | 2.4.8              | As Received            | N/mm              | 1.6                  |                     |               |
| 剥离强度 Peel Strength (RTF)  |                          | 1oz                  |                    |                        |                   | \                    |                     |               |
| 剥离强度 Peel Strength (HVLP) |                          | 1oz                  |                    |                        |                   | \                    |                     |               |
| 弯曲强度<br>Flexural Strength |                          | Warp                 | 2.4.4              | As Received            | N/mm <sup>2</sup> | 600                  |                     |               |
|                           |                          | Fill                 |                    |                        |                   | 500                  |                     |               |
| 耐燃性 Flame Resistance      |                          |                      | UL-94              | A&E-4/125              | -                 | V-0                  |                     |               |